# Qualcom

RF360 Europe GmbH

# **Data sheet**

SAW RF uplink filter Base stations LTE band 28

Series/type:	B5328
Ordering code:	B39731B5328U410
Date:	May 15, 2019
Version:	2.2

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SAW RF uplink filter B5328 Data sheet

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#### 1 Application

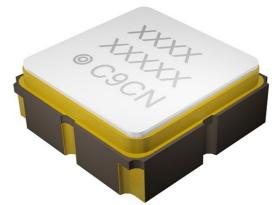
■ RF filter for band 28 uplink

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- Unblanced to unblanced operation
- Low amplitude ripple
- Usable pass band 45 MHz
- $\blacksquare$  No matching required for operation at 50  $\Omega$

#### 2 Features

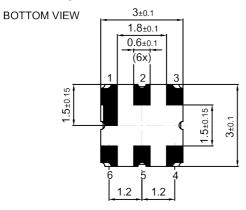
- Package code DCC6C
- Package size 3.0±0.1 mm × 3.0±0.1 mm
- Package height 1.1±0.125 mm
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Lead free soldering compatible with J-STD20C
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)



**Figure 1:** Picture of component with example of product marking.



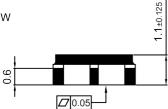
#### 3 Package





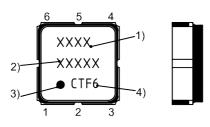
- **2** Input
- **5** Output
- 1, 3, 4, 6 Ground





TOP VIEW

SIDE VIEW



1)Device designation 2)Last five digits of the lot number 3)Marking for pad number 1 4)Example of production location and date code

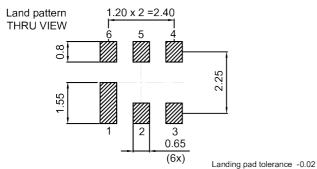


Figure 2: Drawing of package. See Sec. Package information (p. 18).

Please read Cautions and warnings and Important notes at the end of this document.



#### 5 Matching circuit

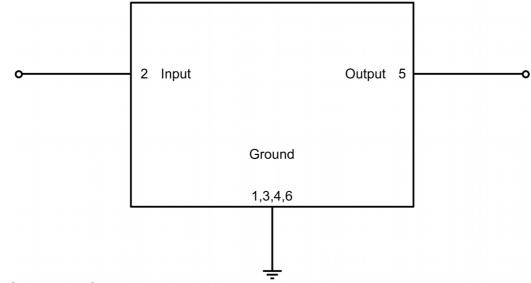


Figure 3: Schematic of matching circuit. No external matching components required.

#### 6 Characteristics

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Temperature range for specification	T <sub>SPEC</sub>	= −40 °C +105 °C
Input terminating impedance	Z	= 50 Ω
Output terminating impedance	Z <sub>OUT</sub>	= 50 Ω

Characteristics				min. for $T_{\rm SPEC}$	<b>typ.</b> @ +25 °C	max. for $T_{\rm SPEC}$	
Center frequency			f <sub>c</sub>	—	725.5	—	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	703 748	MHz		_	2.5	3.5	dB
Amplitude ripple (p-p)			Δα				
	703 748	MHz		—	1.8	2.3 <sup>1)</sup>	dB
	703 748	MHz		—	1.8	2.7	dB
Group delay ripple			$\Delta  au_{ m var}$				
	703 748	MHz		_	50	90	ns
Maximum VSWR			VSWR <sub>max</sub>				
@ input port	703 748	MHz		_	1.8	2.5	
@ output port	703 748	MHz		_	1.8	2.5	
Minimum attenuation			$\alpha_{_{min}}$				
	10 470	MHz		33	36	_	dB
	470 683	MHz		30	35	_	dB
	683 693	MHz		10	30	—	dB
	758 760	MHz		15	30	—	dB
	760 803	MHz		30	35	—	dB
	803 871	MHz		35	40	—	dB
	871 1000	MHz		32	38	—	dB
	1000 1500	MHz		28	33	—	dB
	1500 2800	MHz		23	32	—	dB
	2800 4600	MHz		3	8	—	dB
	4600 5000	MHz		0	5	—	dB

<sup>1)</sup> Valid for temperature T = -40 °C...+90 °C.

#### 7 **Maximum ratings**

Operable temperature	T <sub>op</sub> = −40 °C +105 °C	
Storage temperature	$T_{\rm STG}^{(1)} = -40 ^{\circ}{\rm C} \dots +105 ^{\circ}{\rm C}$	
DC voltage	$ V_{\rm DC} ^{2} = 0 V$	
ESD voltage		
	$V_{\rm ESD}^{3}$ = 100 V	Machine model.
	$V_{\rm ESD}^{4)}$ = 150 V	Human body model.
Input power	P <sub>IN</sub>	
@ input port	25 dBm	Continuous wave for 25 h @ 105 °C.
@ input port	15 dBm	5 MHz LTE uplink signal (25 RB) for 50000 h @ 90 °C.

1) Not valid for packaging material. Please refer to definition of Shelf life (p. 17).

2)

In case of applied DC voltage blocking capacitors are mandatory. According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. 3)

4) According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

#### 8 Transmission coefficient

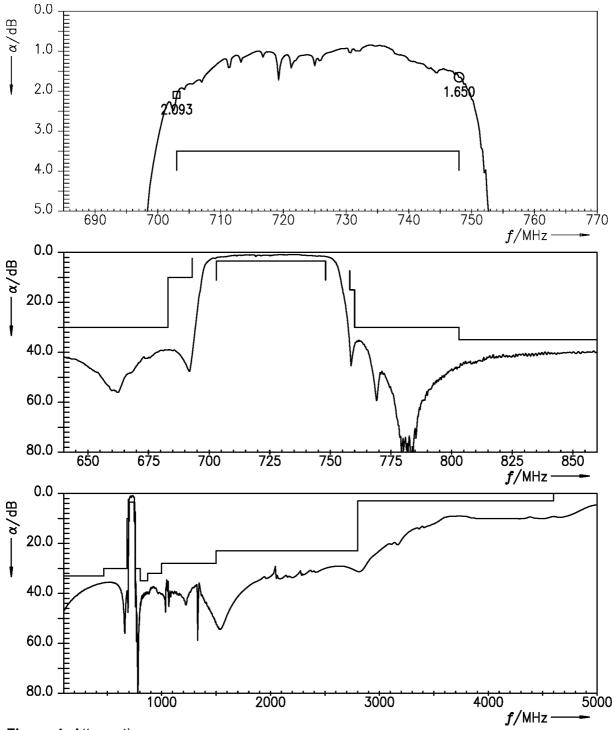


Figure 4: Attenuation.

Please read **Cautions and warnings** and **Important notes** at the end of this document.

□ = 703.0 O = 748.0

Z<sub>IN</sub>=50 Ω

#### 9 Reflection coefficients

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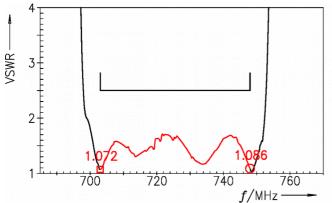


Figure 5: Reflection coefficient at input port.

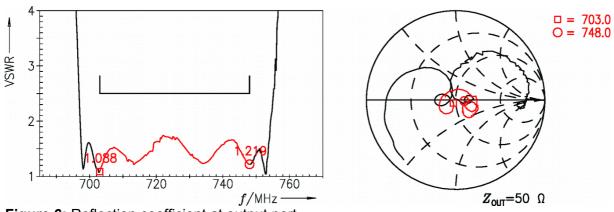


Figure 6: Reflection coefficient at output port.

#### 10 Group delay

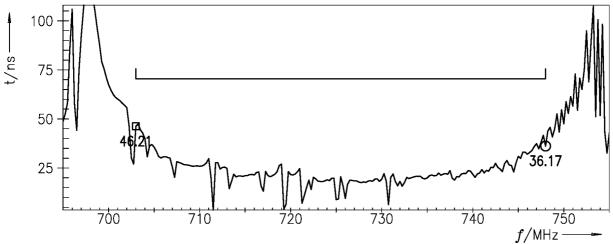
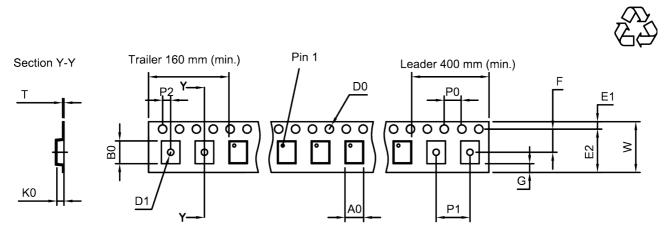


Figure 7: Group delay ripple.



#### 11 Packing material

#### 11.1 Tape



User direction of unreeling

**Figure 8:** Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

 A₀
 3.25±0.1 mm

 B₀
 3.3±0.1 mm

 D₀
 1.5±0.1/-0 mm

 D₁
 1.5 mm (min.)

 E₁
 1.75±0.1 mm

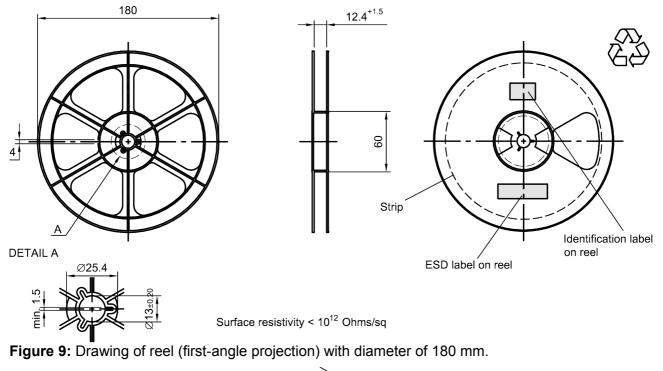
Table 1: Tape dimensions.

E2	10.25 mm (min.)
F	5.5±0.05 mm
G	0.75 mm (min.)
K <sub>0</sub>	1.5±0.1 mm
P <sub>0</sub>	4.0±0.1 mm

P <sub>1</sub>	4.0±0.1 mm
P <sub>2</sub>	2.0±0.1 mm
Т	0.3±0.05 mm
W	12.0+0.3/-0.1 mm



#### 11.2 Reel with diameter of 180 mm



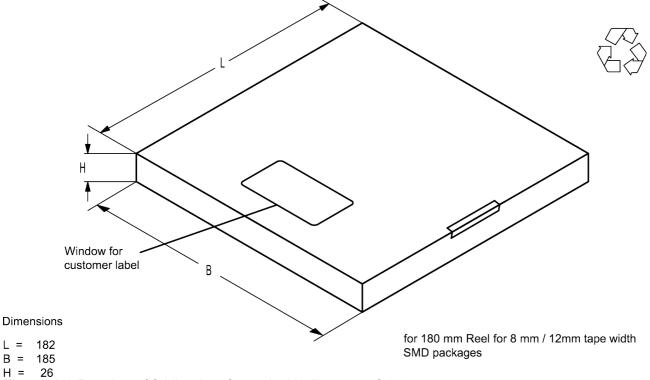


Figure 10: Drawing of folding box for reel with diameter of 180 mm.



#### 11.3 Reel with diameter of 330 mm

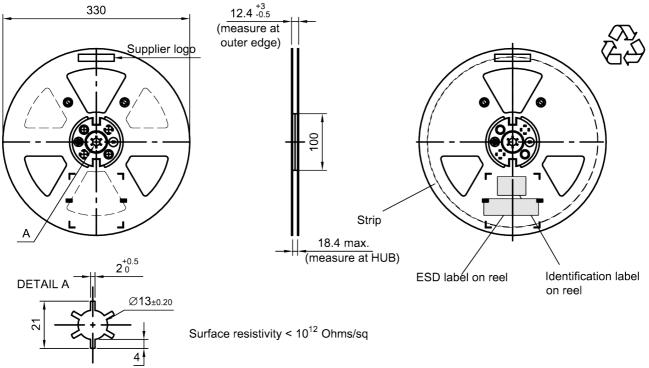


Figure 11: Drawing of reel (first-angle projection) with diameter of 330 mm.

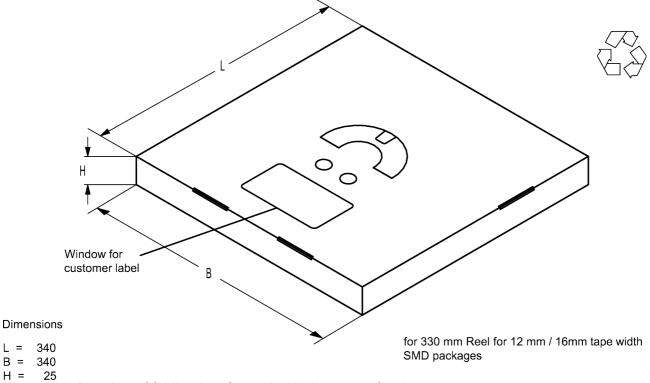


Figure 12: Drawing of folding box for reel with diameter of 330 mm.

### 12 Marking

Products are marked with device designation, lot number, as well as production location and date code.

Device designation: The 4-character device designation of the ordering code is used for the marking.

Example for 4-character device designation: B3xxxxB1234xxxx

■ Lot number: The last 5 digits of the lot number are used for the marking.

Example: 12345

Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.

	1 <sup>st</sup> digit (day)					2 <sup>nd</sup> digit (year)				3 <sup>rd</sup> digit	(month)		
Day	Code	Day	Code	Day	Code	Year	Code	Year	Code	Month	Code	Month	Code
1	1	11	А	21	М	2010	А	2022	Р	Jan	1	Jul	7
2	2	12	В	22	N	2011	В	2023	R	Feb	2	Aug	8
3	3	13	С	23	Р	2012	С	2024	S	Mar	3	Sep	9
4	4	14	D	24	R	2013	D	2025	Т	Apr	4	Oct	0
5	5	15	E	25	S	2014	Е	2026	U	May	5	Nov	N
6	6	16	F	26	Т	2015	F	2027	V	Jun	6	Dec	D
7	7	17	н	27	U	2016	Н	2028	W				
8	8	18	J	28	V	2017	J	2029	Х				
9	9	19	к	29	W	2018	К	2030	Z				
10	0	20	L	30	Х	2019	L	2031	А				
				31	Z	2020	М	2032	В				
						2021	Ν	and	so on				

 Table 2: Production date code.

Example of how to decode production location and date code:

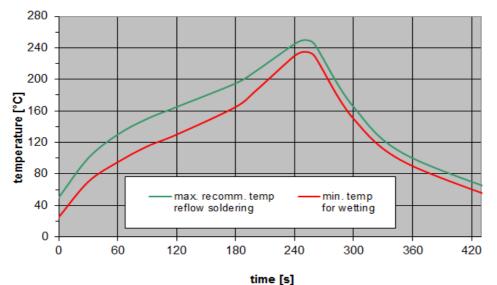
Location:	С		$\rightarrow$	Wuxi
Day:	Т		$\rightarrow$	26 <sup>th</sup>
Year:	F		$\rightarrow$	2015
Month:		6	$\rightarrow$	June

## 13 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3<sup>rd</sup> edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
<i>T</i> > 220 °C	30 s to 70 s
<i>T</i> > 230 °C	min. 10 s
<i>T</i> > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature $T_{peak}$	250 °C +0/-5 °C
wetting temperature $T_{min}$	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 13:** Recommended reflow profile for convection and infrared soldering – lead-free solder.

#### 14 Annotations

#### 14.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

#### 14.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

#### 14.3 Shelf life

The shelf life of components is determined by solderability of the package terminals. It is specified as 2 years from manufacturing date assuming the following conditions:

- storage in original packaging and non-aggressive atmosphere,
- storage temperature ranging from −25 °C to +40 °C, and
- storage humidity with ≤ 75 % r.h. mean annual humidity, ≤ 95 % r.h. for max. 30 days / year, and no dew condensation.

#### 15 Cautions and warnings

#### 15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under <u>www.rf360jv.com/orderingcodes</u>.

#### 15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

#### 15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

#### 15.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

#### **Projection method**

Unless otherwise specified first-angle projection is applied.

#### 16 Important notes

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- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
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